IPC ASSOCIATION ELECTRONIC	Material Compo © Copyright 2005. II s INDUSTRIES® international and Pan	osition De PC, Bannock n-American c	eclaration burn, Illinois. A opyright conver	all rights reserved	under both	This docume level parts, t	ent is a declar the declaration	ration on enco	of the substances ompasses all lowe	within er level	the manufacti materials for v	urer listed it which the m	em. N anufa	Note: if th acturer ha	e item is an as s engineering	ssembly with low responsibility.	
1752-21.1 IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information											
upplier	· Information																
Company name* Company u				ique ID			Unique ID Authority					Respons	Response Date*				
nsemi												2025-06-	2025-06-03				
Contact N	ame		Title - Contac	Title - Contact			Phone - Contact*				Email - 0	Email - Contact*					
Product-I	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
uthorize	d Representative*		Title - Repres	Title - Representative			Phone - Representative*				Email - Representative*						
Product-I	Env-Stewards		Product Envi	uct Enviro Compliance NA					P				Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Da	ate \	Version	Manufa	cturing Site	V	Weight* UOM Unit Typ			Unit Type	
	MT9P03		31112STC-TP 5 MP 1/3 CIS				2025-06-03 TA1			259.0			mg	Each			
Ianufa	cturing Proccess Informat	tion					,									·	
Terminal Plating / Grid Array Material T		Terminal Base A	Alloy	J-STD-020 MS		Peak Proces		ss Body Temperature Max Tim		x Time at Pea	Time at Peak Temperature		Number of Reflow Cycles				
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy		4		260		C 30		secono	ds	3					
omments											<u> </u>				<u> </u>		
			·											·			
or more	information regarding material	composition	please refer to	page 3							·				·		

RoHS Material Composition Declaration			Declaration Type *	Detail	led
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an		
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the co	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit ide in you believe may apply. If the part is an assembly is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not e at least as comprehensive as the hts and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	59.5	mg		Misc.	proprietary data		0.2261	mg
			Supplier	Silicon (Si)	7440-21-3		58.6848	mg
			Supplier	Aluminum (Al)	7429-90-5		0.589	mg
Die Attach	2.2	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.825	mg
			Supplier	Ethylene Glycol	107-21-1		0.022	mg
			Supplier	Sulfonium (Thiodi-4,1-phenylene)	89452-37-9		0.066	mg
			Supplier	Modified Silicon Dioxide (SiO2)	67762-90-7		0.462	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.825	mg
Imaging Lens	55.3	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		2.765	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		2.765	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		2.765	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		2.765	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.2765	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2.765	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		2.765	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		38.4335	mg
Lid Attach	2.4	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.7584	mg
			Supplier	Filler (SiO2)	68909-20-6		0.1248	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		0.7584	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.7584	mg
Mold Compound-Black	55.0	mg		Phenolic Resin	proprietary data		8.25	mg
			Supplier	Oxirane	39817-09-9		8.25	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		1.65	mg
			Supplier	Carbon Black (C)	1333-86-4		0.55	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		35.2	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.1	mg
Substrate and Solder Mask	84.3	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		17.8632	mg
			Supplier	Inorganic Filler of Solder Mask_Talc (Mg3Si4O10(OH)2)	14807-96-6		1.1043	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2782	mg
			Supplier	Acetophenone Derivative	Proprietary Data		1.6523	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2782	mg

			Supplier	2,4-Diethyl-9H-thioxanthen-9-one (DETX)	82799-44-8	0.2782	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2	8.194	mg
			Supplier	Solvent Naphtha (Solvent oil)	64742-94-5	3.3046	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data	2.8325	mg
			Supplier	Copper (Cu)	7440-50-8	39.9666	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7	8.548	mg
Wire Bond - Au	0.3	mg	Supplier	Gold (Au)	7440-57-5	0.3	mg